

## Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- Green Device Available

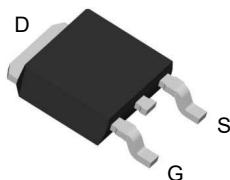
## Product Summary



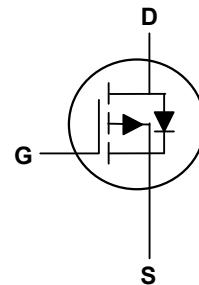
|                                   |     |    |
|-----------------------------------|-----|----|
| $V_{DS}$                          | -60 | V  |
| $I_D$                             | -45 | A  |
| $R_{DS(ON)}$ (at $V_{GS}=-10V$ )  | 25  | mΩ |
| $R_{DS(ON)}$ (at $V_{GS}=-4.5V$ ) | 40  | mΩ |

## Applications

- High Frequency Point-of-Load,Synchronous Buck Converter
- Networking DC-DC Power System
- Load Switch



TO-252 Top View



## Absolute Maximum Ratings( $T_c=25^\circ C$ , unless otherwise noted)

| Parameter                                  | Symbol                    | Rating     | Units |
|--|---------------------------|------------|-------|
| Drain-Source Voltage                       | $V_{DS}$                  | -60        | V     |
| Gate-Source Voltage                        | $V_{GS}$                  | $\pm 20$   | V     |
| Continuous Drain Current <sup>1</sup>      | $I_D @ T_c = 25^\circ C$  | -45        | A     |
| Continuous Drain Current <sup>1</sup>      | $I_D @ T_c = 100^\circ C$ | -28        | A     |
| Pulsed Drain Current <sup>2</sup>          | $I_{DM}$                  | -140       | A     |
| Single Pulse Avalanche Energy <sup>3</sup> | EAS                       | 101        | mJ    |
| Avalanche Current                          | $I_{AS}$                  | 45.5       | A     |
| Total Power Dissipation <sup>4</sup>       | $P_D @ T_c = 25^\circ C$  | 85         | W     |
| Storage Temperature Range                  | $T_{STG}$                 | -55 to 150 | °C    |
| Operating Junction Temperature Range       | $T_J$                     | -55 to 150 | °C    |

## Thermal Characteristics

| Parameter  | Symbol          | Typ | Max | Unit |
|--|-----------------|-----|-----|------|
| Thermal Resistance Junction-Ambient <sup>1</sup> | $R_{\theta JA}$ | --- | 50  | °C/W |
| Thermal Resistance Junction-Case <sup>1</sup>    | $R_{\theta JC}$ | --- | 1.1 | °C/W |

**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**

| Parameter  | Symbol                                     | Conditions   | Min  | Typ    | Max       | Unit                       |
|--|--|--|------|--------|-----------|----------------------------|
| Drain-Source Breakdown Voltage                     | $\text{BV}_{\text{DSS}}$                   | $V_{\text{GS}}=0\text{V}$ , $I_D=-250\mu\text{A}$  | -60  | ---    | ---       | V                          |
| $\text{BV}_{\text{DSS}}$ Temperature Coefficient   | $\Delta \text{BV}_{\text{DSS}}/\Delta T_J$ | Reference to $25^\circ\text{C}$ , $I_D=-1\text{mA}$  | ---  | -0.035 | ---       | $\text{V}/^\circ\text{C}$  |
| Static Drain-Source On-Resistance <sup>2</sup>     | $R_{\text{DS}(\text{ON})}$                 | $V_{\text{GS}}=-10\text{V}$ , $I_D=-20\text{A}$  | ---  | ---    | 25        | $\text{m}\Omega$           |
|  |  | $V_{\text{GS}}=-4.5\text{V}$ , $I_D=-15\text{A}$   | ---  | ---    | 40        | $\text{m}\Omega$           |
| Gate Threshold Voltage                             | $V_{\text{GS}(\text{th})}$                 | $V_{\text{GS}}=V_{\text{DS}}$ , $I_D = -250\mu\text{A}$  | -1.0 | ---    | -3.0      | V                          |
| $V_{\text{GS}(\text{th})}$ Temperature Coefficient | $\Delta V_{\text{GS}(\text{th})}$          |  | ---  | 4.25   | ---       | $\text{mV}/^\circ\text{C}$ |
| Drain-Source Leakage Current                       | $I_{\text{DSS}}$                           | $V_{\text{DS}}=-48\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$               | ---  | ---    | 1         | $\mu\text{A}$              |
|  |  | $V_{\text{DS}}=-48\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=55^\circ\text{C}$               | ---  | ---    | 5         | $\mu\text{A}$              |
| Gate-Source Leakage Current                        | $I_{\text{GSS}}$                           | $V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$                                     | ---  | ---    | $\pm 100$ | nA                         |
| Forward Transconductance                           | $g_{\text{fs}}$                            | $V_{\text{DS}}=-10\text{V}$ , $I_D=-20\text{A}$  | ---  | 22     | ---       | S                          |
| Gate Resistance                                    | $R_g$                                      | $V_{\text{DS}}=0\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$                        | ---  | 7      | ---       | $\Omega$                   |
| Total Gate Charge                                  | $Q_g$                                      | $V_{\text{DS}}=-20\text{V}$ , $V_{\text{GS}}=-10\text{V}$ , $I_D=12\text{A}$                   | ---  | 56     | ---       | nC                         |
| Gate-Source Charge                                 | $Q_{\text{gs}}$                            |  | ---  | 6.7    | ---       |                            |
| Gate-Drain Charge                                  | $Q_{\text{gd}}$                            |  | ---  | 5.5    | ---       |                            |
| Turn-On Delay Time                                 | $T_{\text{d}(\text{on})}$                  | $V_{\text{DD}}=-15\text{V}$ , $V_{\text{GS}}=-10\text{V}$ , $R_G=3.3\Omega$ , $I_D=-1\text{A}$ | ---  | 38     | ---       | ns                         |
| Rise Time  | $T_r$                                      |  | ---  | 23.6   | ---       |                            |
| Turn-Off Delay Time                                | $T_{\text{d}(\text{off})}$                 |  | ---  | 100    | ---       |                            |
| Fall Time  | $T_f$                                      |  | ---  | 6.8    | ---       |                            |
| Input Capacitance                                  | $C_{\text{iss}}$                           | $V_{\text{DS}}=-15\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$                      | ---  | 3635   | ---       | pF                         |
| Output Capacitance                                 | $C_{\text{oss}}$                           |  | ---  | 224    | ---       |                            |
| Reverse Transfer Capacitance                       | $C_{\text{rss}}$                           |  | ---  | 141    | ---       |                            |

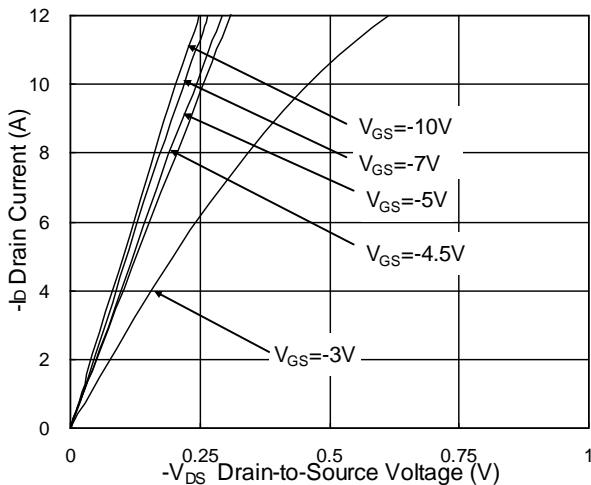
**Drain-Source Diode Characteristics**

| Parameter                                | Symbol          | Conditions   | Min | Typ | Max  | Unit |
|--|-----------------|--|-----|-----|------|------|
| Continuous Source Current <sup>1,5</sup> | $I_s$           | $V_G=V_D=0\text{V}$ , Force Current                                    | --- | --- | -45  | A    |
| Pulsed Source Current <sup>2,5</sup>     | $I_{\text{SM}}$ |  | --- | --- | -140 | A    |
| Diode Forward Voltage <sup>2</sup>       | $V_{\text{SD}}$ | $V_{\text{GS}}=0\text{V}$ , $I_s=-25\text{A}$ , $T_J=25^\circ\text{C}$ | --- | --- | -1.2 | V    |

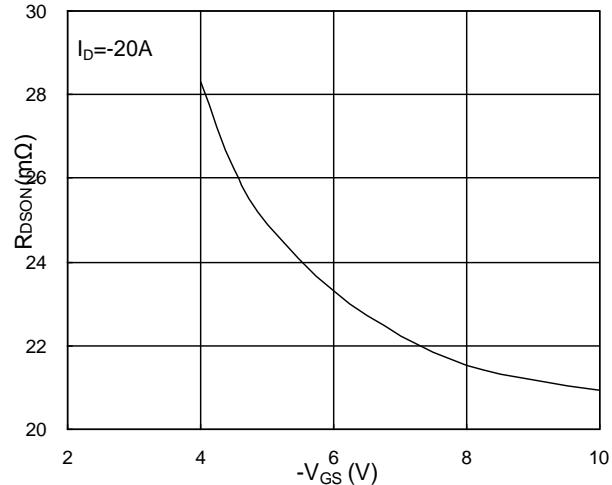
**Note:**

- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leq 300\mu\text{s}$  , duty cycle  $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is  $V_{\text{DD}}=-30\text{V}$ , $V_{\text{GS}}=-10\text{V}$ , $L=0.1\text{mH}$
- 4.The power dissipation is limited by  $150^\circ\text{C}$  junction temperature

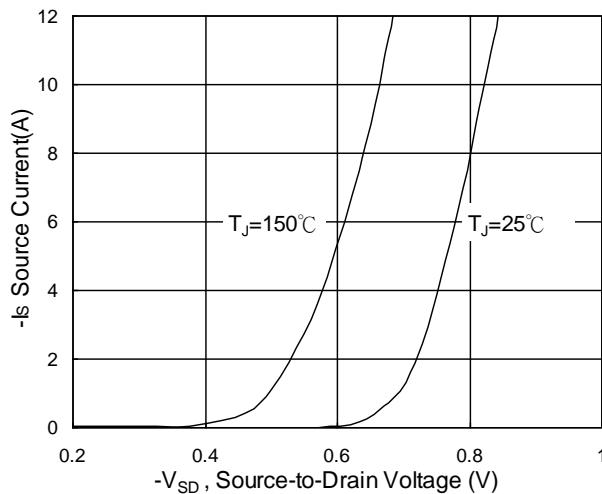
## Typical Characteristics



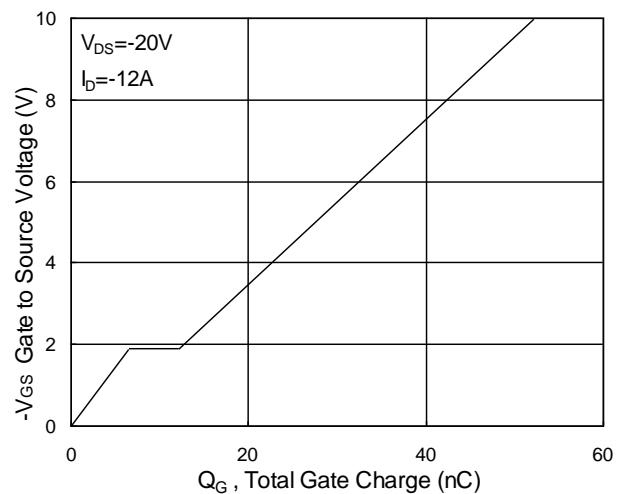
**Fig.1 Typical Output Characteristics**



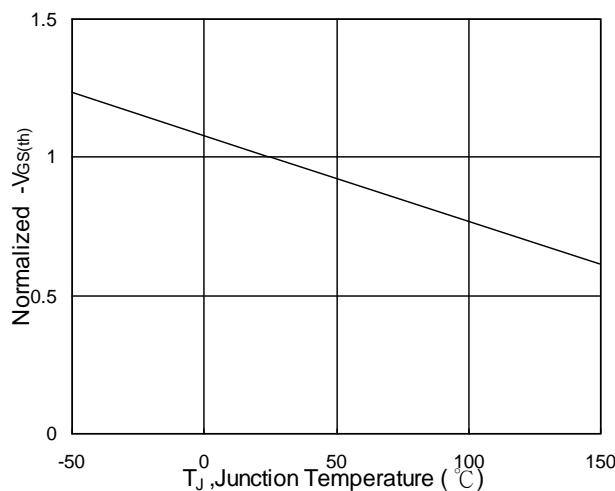
**Fig.2 On-Resistance vs. G-S Voltage**



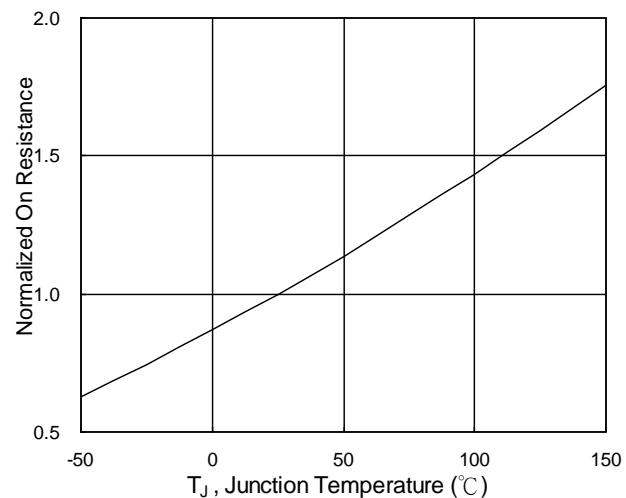
**Fig.3 Forward Characteristics of Reverse**



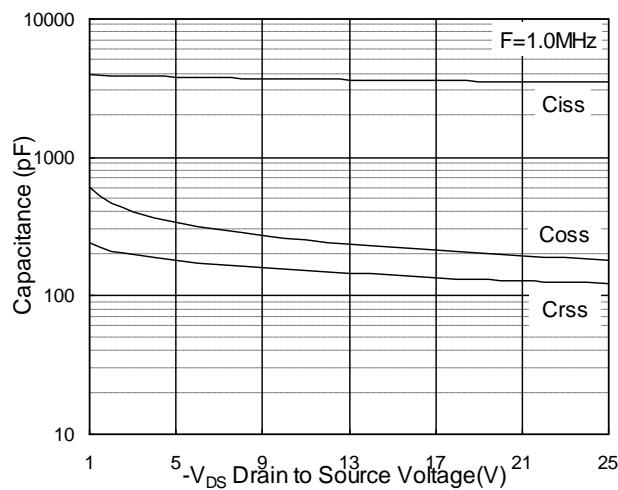
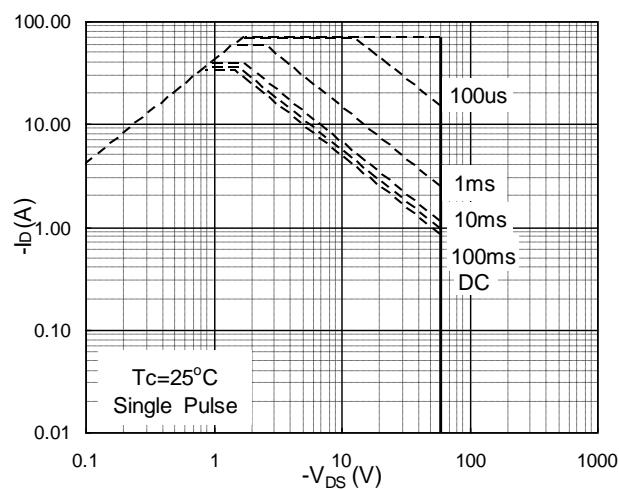
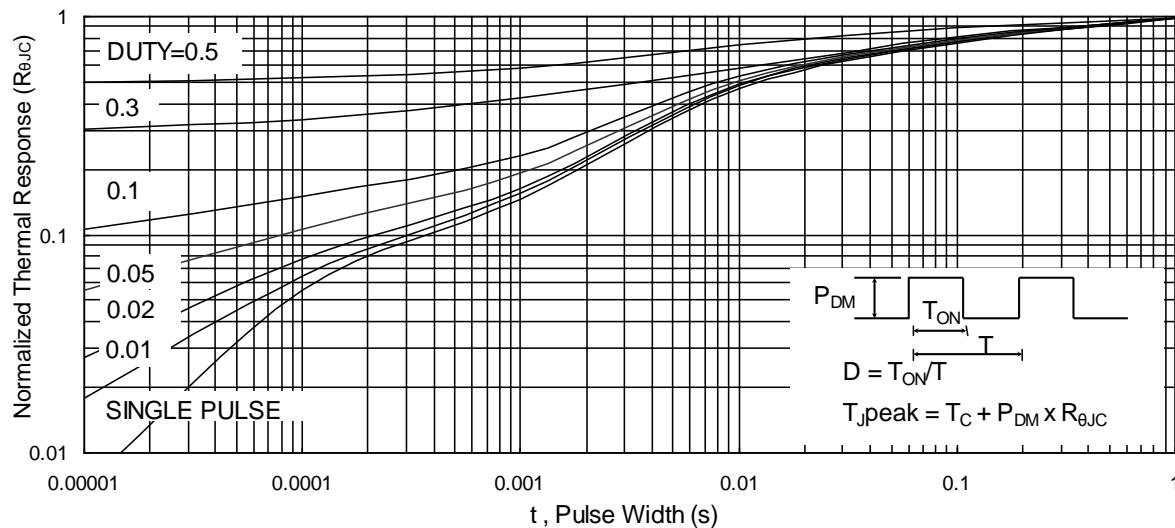
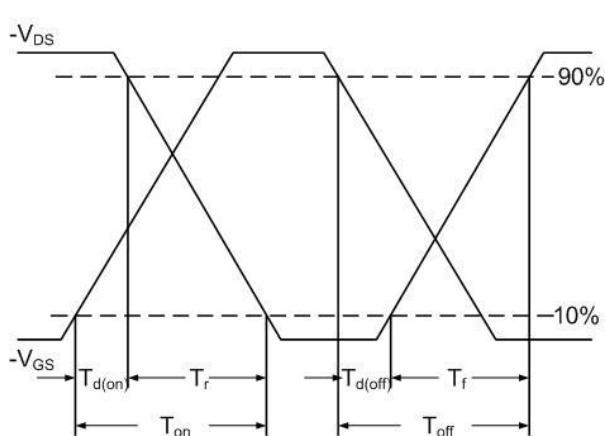
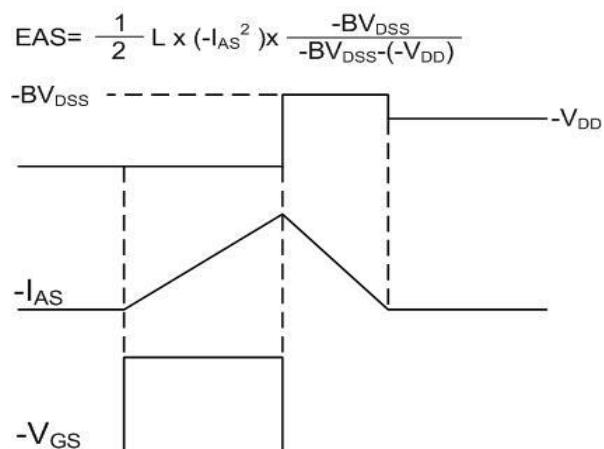
**Fig.4 Gate-Charge Characteristics**



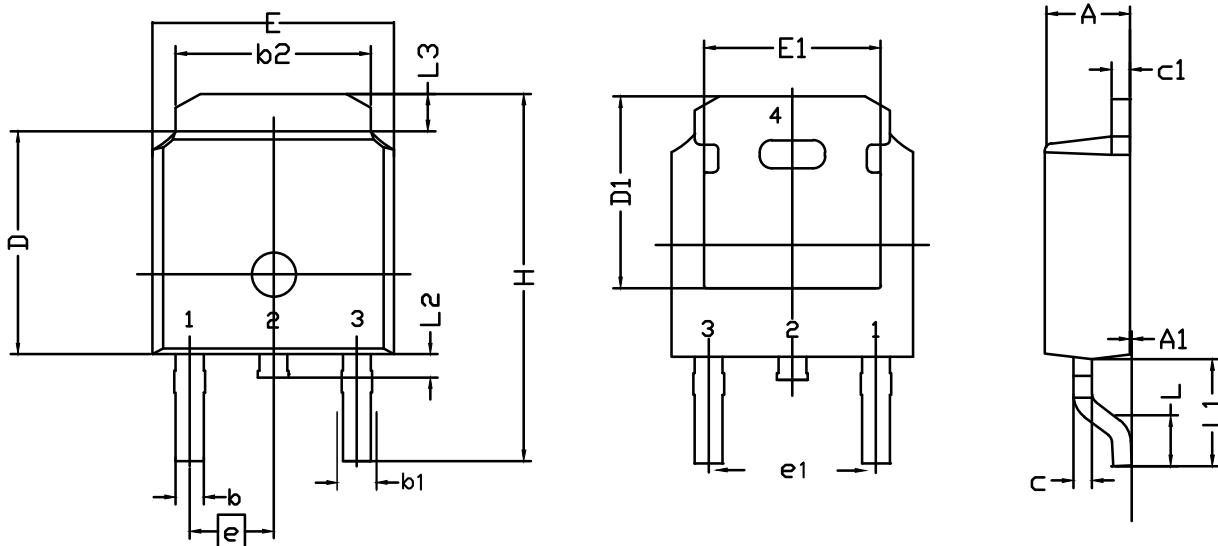
**Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$**



**Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$**


**Fig.7 Capacitance**

**Fig.8 Safe Operating Area**

**Fig.9 Normalized Maximum Transient Thermal Impedance**

**Fig.10 Switching Time Waveform**

**Fig.11 Unclamped Inductive Waveform**

### TO-252 Package Outline Dimensions



| <b>Symbol</b>        | <b>Dimensions (unit:mm)</b> |            |            | <b>Symbol</b>        | <b>Dimensions (unit:mm)</b> |            |            |
|----------------------|-----------------------------|------------|------------|----------------------|-----------------------------|------------|------------|
|                      | <b>Min</b>                  | <b>Typ</b> | <b>Max</b> |                      | <b>Min</b>                  | <b>Typ</b> | <b>Max</b> |
| <b>A</b>             | 2.20                        | 2.30       | 2.38       | <b>E</b>             | 6.40                        | 6.60       | 6.731      |
| <b>A<sub>1</sub></b> | 0.00                        | 0.10       | 0.20       | <b>E<sub>1</sub></b> | 4.40                        | --         | --         |
| <b>b</b>             | 0.64                        | 0.76       | 0.89       | <b>e</b>             | 2.286 BSC                   |            |            |
| <b>b<sub>1</sub></b> | 0.77                        | 0.85       | 1.14       | <b>e<sub>1</sub></b> | 4.572 BSC                   |            |            |
| <b>b<sub>2</sub></b> | 5.00                        | 5.33       | 5.46       | <b>H</b>             | 9.40                        | 10.00      | 10.40      |
| <b>c</b>             | 0.458                       | 0.508      | 0.610      | <b>L</b>             | 1.40                        | 1.52       | 1.77       |
| <b>C<sub>1</sub></b> | 0.458                       | 0.508      | 0.620      | <b>L<sub>1</sub></b> | --                          | 2.743      | --         |
| <b>D</b>             | 5.98                        | 6.10       | 6.223      | <b>L<sub>2</sub></b> | 0.60                        | 0.80       | 1.01       |
| <b>D<sub>1</sub></b> | 5.20                        | 5.25       | 5.38       | <b>L<sub>3</sub></b> | 0.90                        | 1.06       | 1.25       |